

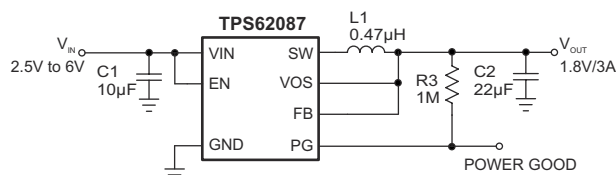
# TPS6208x ヒカッパ短絡保護搭載、 2mm × 2mm VSON パッケージの 3A 降圧型コンバータ

## 1 特長

- DCS-Control™ トポロジ
- 最大 95% の効率
- ヒカッパ短絡保護機能
- パワー・セーブ・モードにより軽負荷時の効率を向上
- 100% デューティ・サイクル動作による最小のドロップアウト電圧
- 2.5V~6.0V の入力電圧範囲
- 動作時静止電流: 17μA
- 出力電圧は 0.8V~V<sub>IN</sub> まで可変
- 1.8V~3.3V の固定出力電圧
- 出力放電
- パワー・グッド出力
- サーマル・シャットダウン保護機能
- 2mm × 2mm の VSON パッケージで供給
- WEBENCH Power Designer でカスタム設計を作成
  - TPS62085 [WEBENCH® Power Designer](#)
  - TPS62086 [WEBENCH® Power Designer](#)
  - TPS62087 [WEBENCH® Power Designer](#)

## 2 アプリケーション

- [バッテリー駆動のアプリケーション](#)
- [ポイントオブロード](#)
- [プロセッサ用電源](#)
- [ハード・ディスク・ドライブ](#)



代表的なアプリケーション回路図

## 3 概要

TPS62085、TPS62086、TPS62087 デバイスは高周波数の同期降圧型コンバータで、ソリューションの小型化と高効率のために最適化されています。入力電圧範囲は 2.5V~6.0V で、一般的なバッテリー・テクノロジーをサポートします。

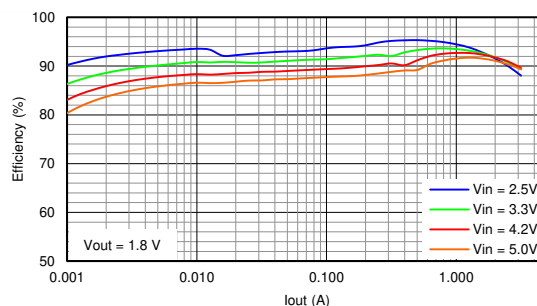
このデバイスは、広い出力電流範囲にわたって高い効率で降圧変換を行うことを主眼としています。中負荷から重負荷では PWM モードで動作し、軽負荷時には自動的に省電力モードへ移行するため、負荷電流の全範囲にわたって高効率が維持されます。

システム電源レールの要件に対処するため、内部補償回路は 10μF~150μF の範囲で、多くの外部出力コンデンサの値を選択できます。また、DCS-Control アーキテクチャにより、優れた負荷過渡性能と出力電圧レギュレーション精度を実現しています。このデバイスは、2mm × 2mm の VSON パッケージで供給されます。

### 製品情報

| 部品番号     | パッケージ <sup>(1)</sup> | 本体サイズ (公称)      |
|----------|----------------------|-----------------|
| TPS62085 | VSON (7)             | 2.00mm × 2.00mm |
| TPS62086 |                      |                 |
| TPS62087 |                      |                 |

- (1) 利用可能なすべてのパッケージについては、このデータシートの末尾にある注文情報を参照してください。



標準的なアプリケーションの効率



## Table of Contents

|                                                |          |                                                  |           |
|------------------------------------------------|----------|--------------------------------------------------|-----------|
| <b>1 特長</b> .....                              | <b>1</b> | 8.4 Device Functional Modes.....                 | <b>9</b>  |
| <b>2 アプリケーション</b> .....                        | <b>1</b> | <b>9 Application and Implementation</b> .....    | <b>10</b> |
| <b>3 概要</b> .....                              | <b>1</b> | 9.1 Application Information.....                 | 10        |
| <b>4 Revision History</b> .....                | <b>2</b> | 9.2 Typical Application.....                     | 10        |
| <b>5 Device Options</b> .....                  | <b>3</b> | <b>10 Power Supply Recommendations</b> .....     | <b>16</b> |
| <b>6 Pin Configuration and Functions</b> ..... | <b>3</b> | <b>11 Layout</b> .....                           | <b>16</b> |
| <b>7 Specifications</b> .....                  | <b>4</b> | 11.1 Layout Guidelines.....                      | 16        |
| 7.1 Absolute Maximum Ratings.....              | 4        | 11.2 Layout Example.....                         | 16        |
| 7.2 ESD Ratings.....                           | 4        | 11.3 Thermal Considerations.....                 | 16        |
| 7.3 Recommended Operating Conditions.....      | 4        | <b>12 Device and Documentation Support</b> ..... | <b>17</b> |
| 7.4 Thermal Information.....                   | 4        | 12.1 Device Support.....                         | 17        |
| 7.5 Electrical Characteristics.....            | 5        | 12.2 Documentation Support.....                  | 17        |
| 7.6 Typical Characteristics.....               | 6        | 12.3 ドキュメントの更新通知を受け取る方法.....                     | 17        |
| <b>8 Detailed Description</b> .....            | <b>7</b> | 12.4 サポート・リソース.....                              | 17        |
| 8.1 Overview.....                              | 7        | 12.5 Trademarks.....                             | 17        |
| 8.2 Functional Block Diagram.....              | 7        | 12.6 静電気放電に関する注意事項.....                          | 18        |
| 8.3 Feature Description.....                   | 7        | 12.7 用語集.....                                    | 18        |

## 4 Revision History

資料番号末尾の英字は改訂を表しています。その改訂履歴は英語版に準じています。

| <b>Changes from Revision B (July 2018) to Revision C (January 2021)</b>                                                                          | <b>Page</b> |
|--------------------------------------------------------------------------------------------------------------------------------------------------|-------------|
| • 文書全体にわたって表、図、相互参照の採番方法を更新.....                                                                                                                 | 1           |
| • Changed maximum $I_{PG,LKG}$ specification up to 125°C $T_J$ from 0.16 $\mu A$ to 0.25 $\mu A$ in <i>Electrical Characteristics</i> table..... | 5           |

| <b>Changes from Revision A (June 2015) to Revision B (July 2018)</b>    | <b>Page</b> |
|-------------------------------------------------------------------------|-------------|
| • 「特長」の一覧でパッケージ名を QFN から VSON に変更.....                                  | 1           |
| • Webench のリンクをデータシートに追加.....                                           | 1           |
| • Added SW node AC value in <i>Absolute Maximum Ratings</i> table ..... | 4           |
| • Changed $f_{PFM}$ To: $f_{PSM}$ in 式 1 .....                          | 7           |
| • Added 図 8-1 to <i>Power Save Mode</i> section.....                    | 7           |
| • Added 表 8-1 to <i>Power Good</i> section .....                        | 9           |
| • Changed Murata inductor part number in 表 9-4 .....                    | 11          |

| <b>Changes from Revision * (October 2013) to Revision A (June 2015)</b>                                                                                  | <b>Page</b> |
|----------------------------------------------------------------------------------------------------------------------------------------------------------|-------------|
| • 「ESD 定格」表、「機能説明」セクション、「デバイスの機能モード」セクション、「アプリケーションと実装」セクション、「電源に関する推奨事項」セクション、「レイアウト」セクション、「デバイスおよびドキュメントのサポート」セクション、「メカニカル、パッケージ、および注文情報」セクションを追加..... | 1           |

## 5 Device Options

| PART NUMBER <sup>(1)</sup> | OUTPUT VOLTAGE |
|----------------------------|----------------|
| TPS62085RLT                | Adjustable     |
| TPS62086RLT                | 3.3 V          |
| TPS62087RLT                | 1.8 V          |

(1) For detailed ordering information, please check the [セクション Mechanical, Packaging, and Orderable Information](#) section at the end of this datasheet.

## 6 Pin Configuration and Functions

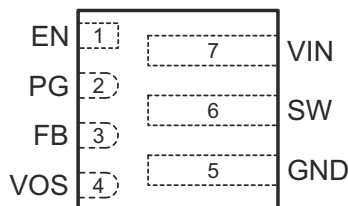


図 6-1. RLT Package 7-Pin VSON Top View

表 6-1. Pin Functions

| PIN  |     | I/O | DESCRIPTION                                                                                                                                                                                            |
|------|-----|-----|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME | NO. |     |                                                                                                                                                                                                        |
| EN   | 1   | IN  | Device enable pin. To enable the device, this pin needs to be pulled high. Pulling this pin low disables the device. This pin has a pulldown resistor of typically 400 kΩ when the device is disabled. |
| FB   | 3   | IN  | Feedback pin. For the fixed output voltage versions this pin must be connected to the output voltage.                                                                                                  |
| GND  | 5   |     | Ground pin.                                                                                                                                                                                            |
| PG   | 2   | OUT | Power good open drain output pin. The pullup resistor can not be connected to any voltage higher than 6 V. If unused, leave it floating.                                                               |
| SW   | 6   | PWR | Switch pin of the power stage.                                                                                                                                                                         |
| VIN  | 7   | PWR | Input voltage pin.                                                                                                                                                                                     |
| VOS  | 4   | IN  | Output voltage sense pin. This pin must be directly connected to the output capacitor.                                                                                                                 |

## 7 Specifications

### 7.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|                                |                                         | MIN  | MAX       | UNIT |
|--------------------------------|-----------------------------------------|------|-----------|------|
| Voltage at Pins <sup>(2)</sup> | VIN, FB, VOS, EN, PG                    | −0.3 | 7         | V    |
|                                | SW (DC)                                 | −0.3 | VIN + 0.3 |      |
|                                | SW (AC, less than 100ns) <sup>(3)</sup> | −3   | 11        |      |
| Temperature                    | Operating Junction, TJ                  | −40  | 150       | °C   |
|                                | Storage, Tstg                           | −65  | 150       | °C   |

(1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to absolute–maximum–rated conditions for extended periods may affect device reliability.

(2) All voltage values are with respect to network ground terminal.

(3) While switching.

### 7.2 ESD Ratings

|                                |                                                                                | VALUE | UNIT |
|--------------------------------|--------------------------------------------------------------------------------|-------|------|
| V(ESD) Electrostatic discharge | Human body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>              | ±2000 | V    |
|                                | Charged device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup> | ±500  |      |

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

### 7.3 Recommended Operating Conditions

|                                   | MIN <sup>(1)</sup> | NOM | MAX <sup>(1)</sup> | UNIT |
|-----------------------------------|--------------------|-----|--------------------|------|
| VIN Input voltage range           | 2.5                |     | 6                  | V    |
| ISINK_PG Sink current at PG pin   |                    |     | 1                  | mA   |
| VPG Pullup resistor voltage       |                    |     | 6                  | V    |
| TJ Operating junction temperature | −40                |     | 125                | °C   |

(1) Refer to [セクション 9](#) for further information.

### 7.4 Thermal Information

| THERMAL METRIC |                                              | TPS6208x   | UNIT |
|----------------|----------------------------------------------|------------|------|
|                |                                              | RLT [VSON] |      |
|                |                                              | 7 PINS     |      |
| RθJA           | Junction-to-ambient thermal resistance       | 107.8      | °C/W |
| RθJC(top)      | Junction-to-case (top) thermal resistance    | 66.2       | °C/W |
| RθJB           | Junction-to-board thermal resistance         | 17.1       | °C/W |
| ψJT            | Junction-to-top characterization parameter   | 2.1        | °C/W |
| ψJB            | Junction-to-board characterization parameter | 17.1       | °C/W |
| RθJC(bot)      | Junction-to-case (bottom) thermal resistance | N/A        | °C/W |

## 7.5 Electrical Characteristics

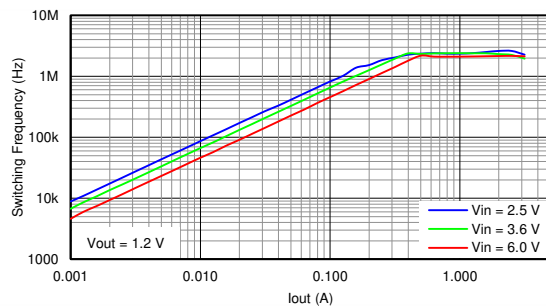
$T_J = -40\text{ }^{\circ}\text{C}$  to  $125\text{ }^{\circ}\text{C}$ , and  $V_{IN} = 3.6\text{ V}$ . Typical values are at  $T_J = 25\text{ }^{\circ}\text{C}$ , unless otherwise noted.

| PARAMETER                     |                                                            | TEST CONDITIONS                                                                                                                                  | MIN   | TYP  | MAX      | UNIT               |
|-------------------------------|------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------|-------|------|----------|--------------------|
| <b>SUPPLY</b>                 |                                                            |                                                                                                                                                  |       |      |          |                    |
| $V_{IN}$                      | Input voltage range                                        |                                                                                                                                                  | 2.5   |      | 6        | V                  |
| $I_Q$                         | Quiescent current into $V_{IN}$                            | No load, device not switching<br>$T_J = -40\text{ }^{\circ}\text{C}$ to $85\text{ }^{\circ}\text{C}$ , $V_{IN} = 2.5\text{ V}$ to $5.5\text{ V}$ |       | 17   | 25       | $\mu\text{A}$      |
| $I_{SD}$                      | Shutdown current into $V_{IN}$                             | EN = Low,<br>$T_J = -40\text{ }^{\circ}\text{C}$ to $85\text{ }^{\circ}\text{C}$ , $V_{IN} = 2.5\text{ V}$ to $5.5\text{ V}$                     |       | 0.7  | 5        | $\mu\text{A}$      |
| $V_{UVLO}$                    | Undervoltage lockout threshold                             | $V_{IN}$ falling                                                                                                                                 | 2.1   | 2.2  | 2.3      | V                  |
|                               | Undervoltage lockout hysteresis                            | $V_{IN}$ rising                                                                                                                                  |       | 200  |          | mV                 |
| $T_{JSD}$                     | Thermal shutdown threshold                                 | $T_J$ rising                                                                                                                                     |       | 150  |          | $^{\circ}\text{C}$ |
|                               | Thermal shutdown hysteresis                                | $T_J$ falling                                                                                                                                    |       | 20   |          | $^{\circ}\text{C}$ |
| <b>LOGIC INTERFACE EN</b>     |                                                            |                                                                                                                                                  |       |      |          |                    |
| $V_{IH}$                      | High-level input voltage                                   | $V_{IN} = 2.5\text{ V}$ to $6.0\text{ V}$                                                                                                        | 1.0   |      |          | V                  |
| $V_{IL}$                      | Low-level input voltage                                    | $V_{IN} = 2.5\text{ V}$ to $6.0\text{ V}$                                                                                                        |       |      | 0.4      | V                  |
| $I_{EN,LKG}$                  | Input leakage current into EN pin                          | EN = High                                                                                                                                        |       | 0.01 | 0.16     | $\mu\text{A}$      |
| $R_{PD}$                      | Pulldown resistance at EN pin                              | EN = Low                                                                                                                                         |       | 400  |          | k $\Omega$         |
| <b>SOFT START, POWER GOOD</b> |                                                            |                                                                                                                                                  |       |      |          |                    |
| $t_{SS}$                      | Soft-start time                                            | Time from EN high to 95% of $V_{OUT}$ nominal                                                                                                    |       | 0.8  |          | ms                 |
| $V_{PG}$                      | Power good threshold                                       | $V_{OUT}$ rising, referenced to $V_{OUT}$ nominal                                                                                                | 93%   | 95%  | 98%      |                    |
|                               |                                                            | $V_{OUT}$ falling, referenced to $V_{OUT}$ nominal                                                                                               | 88%   | 90%  | 93%      |                    |
| $V_{PG,OL}$                   | Low-level output voltage                                   | $I_{sink} = 1\text{ mA}$                                                                                                                         |       |      | 0.4      | V                  |
| $I_{PG,LKG}$                  | Input leakage current into PG pin                          | $V_{PG} = 5.0\text{ V}$ , $T_J = -40\text{ }^{\circ}\text{C}$ to $85\text{ }^{\circ}\text{C}$                                                    |       | 0.01 | 0.16     | $\mu\text{A}$      |
| $I_{PG,LKG}$                  | Input leakage current into PG pin                          | $V_{PG} = 5.0\text{ V}$                                                                                                                          |       | 0.01 | 0.25     | $\mu\text{A}$      |
| <b>OUTPUT</b>                 |                                                            |                                                                                                                                                  |       |      |          |                    |
| $V_{OUT}$                     | Output voltage range, TPS62085                             |                                                                                                                                                  | 0.8   |      | $V_{IN}$ | V                  |
|                               | Output voltage accuracy, TPS62086, TPS62087 <sup>(1)</sup> | $I_{OUT} = 1\text{ A}$ , $V_{IN} \geq V_{OUT} + 1\text{ V}$ , PWM mode                                                                           | -1.0% |      | 1.0%     |                    |
|                               |                                                            | $I_{OUT} = 0\text{ A}$ , $V_{IN} \geq V_{OUT} + 1\text{ V}$ , PSM mode                                                                           | -1.0% |      | 2.1%     |                    |
| $V_{FB}$                      | Feedback regulation voltage <sup>(1) (2)</sup>             | $I_{OUT} = 1\text{ A}$ , $V_{IN} \geq V_{OUT} + 1\text{ V}$ , PWM mode                                                                           | 792   | 800  | 808      | mV                 |
|                               |                                                            | $I_{OUT} = 0\text{ A}$ , $V_{IN} \geq V_{OUT} + 1\text{ V}$ , PSM mode                                                                           | 792   | 800  | 817      |                    |
| $I_{FB,LKG}$                  | Feedback input leakage current                             | $V_{FB} = 1\text{ V}$                                                                                                                            |       | 0.01 | 0.1      | $\mu\text{A}$      |
| $R_{DIS}$                     | Output discharge resistor                                  | EN = LOW, $V_{OUT} = 1.8\text{ V}$                                                                                                               |       | 260  |          | $\Omega$           |
|                               | Line regulation                                            | $I_{OUT} = 1\text{ A}$ , $V_{IN} = 2.5\text{ V}$ to $6.0\text{ V}$                                                                               |       | 0.02 |          | %/V                |
|                               | Load regulation                                            | $I_{OUT} = 0.5\text{ A}$ to $3\text{ A}$                                                                                                         |       | 0.16 |          | %/A                |
| <b>POWER SWITCH</b>           |                                                            |                                                                                                                                                  |       |      |          |                    |
| $R_{DS(on)}$                  | High-side FET ON-resistance                                | $I_{SW} = 500\text{ mA}$                                                                                                                         |       | 31   | 56       | m $\Omega$         |
|                               | Low-side FET ON-resistance                                 | $I_{SW} = 500\text{ mA}$                                                                                                                         |       | 23   | 45       | m $\Omega$         |
| $I_{LIM}$                     | High-side FET switch current limit                         |                                                                                                                                                  | 3.7   | 4.6  | 5.5      | A                  |
| $f_{SW}$                      | PWM switching frequency                                    | $I_{OUT} = 1\text{ A}$                                                                                                                           |       | 2.4  |          | MHz                |

(1) For more information, see [セクション 8.3.1](#).

(2) Conditions:  $L = 0.47\text{ }\mu\text{H}$ ,  $C_{OUT} = 22\text{ }\mu\text{F}$

## 7.6 Typical Characteristics



7-1. Switching Frequency

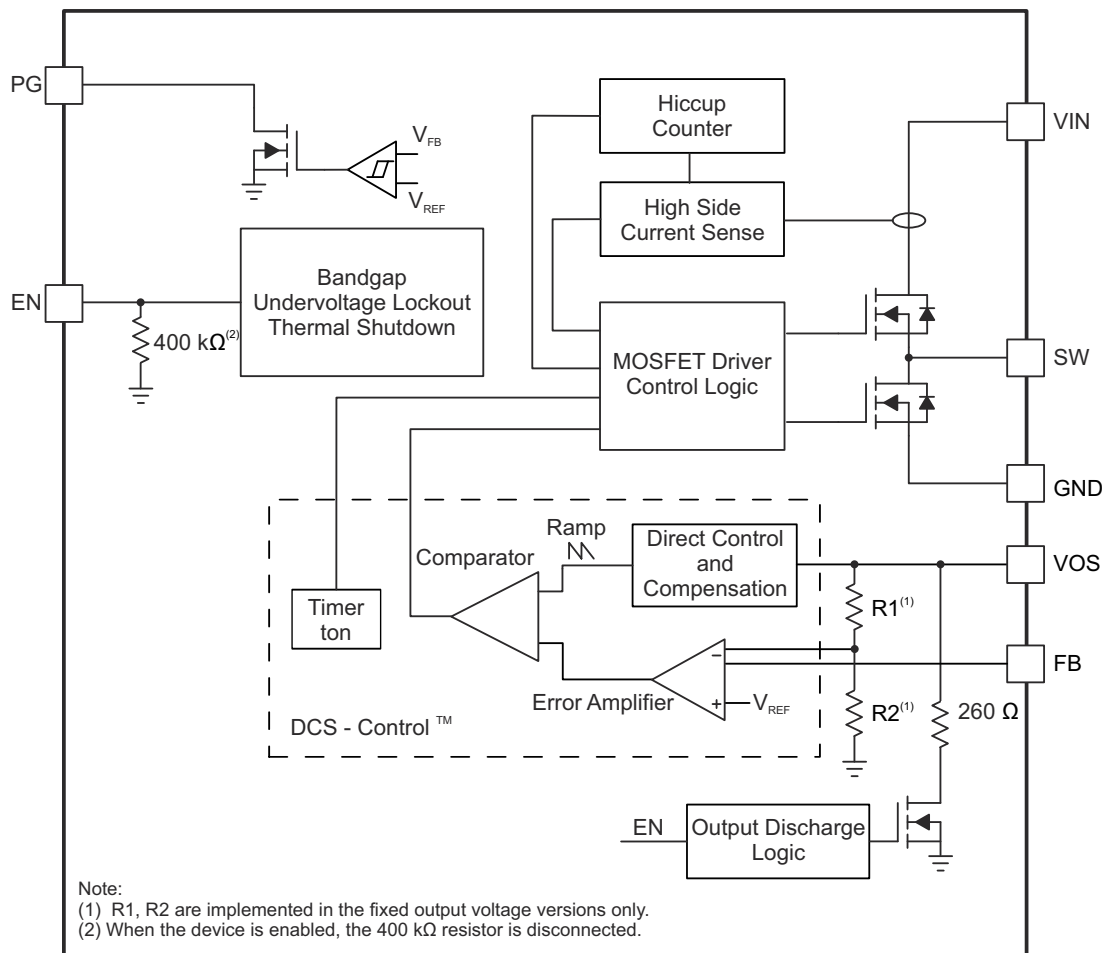
## 8 Detailed Description

### 8.1 Overview

The TPS62085, TPS62086, and TPS62087 synchronous step-down converters are based on the DCS-Control (Direct Control with Seamless transition into Power Save Mode) topology. This is an advanced regulation topology that combines the advantages of hysteretic, voltage, and current mode control schemes.

The DCS-Control topology operates in PWM (pulse width modulation) mode for medium to heavy load conditions and in Power Save Mode at light load currents. In PWM mode, the converter operates with its nominal switching frequency of 2.4 MHz, having a controlled frequency variation over the input voltage range. As the load current decreases, the converter enters Power Save Mode, reducing the switching frequency and minimizing the IC quiescent current to achieve high efficiency over the entire load current range. Because DCS-Control supports both operation modes (PWM and PSM) within a single building block, the transition from PWM mode to Power Save Mode is seamless and without effects on the output voltage. Fixed output voltage version provides smallest solution size combined with lowest no load current. The devices offer both excellent DC voltage and superior load transient regulation, combined with very low output voltage ripple, minimizing interference with RF circuits.

### 8.2 Functional Block Diagram



### 8.3 Feature Description

#### 8.3.1 Power Save Mode

As the load current decreases, the TPS62085, TPS62086, and TPS62087 enter Power Save Mode (PSM) operation. During Power Save Mode, the converter operates with reduced switching frequency and with a minimum quiescent current maintaining high efficiency. The power save mode occurs when the inductor current becomes discontinuous. Power Save Mode is based on a fixed on-time architecture, as related in 式 1. The

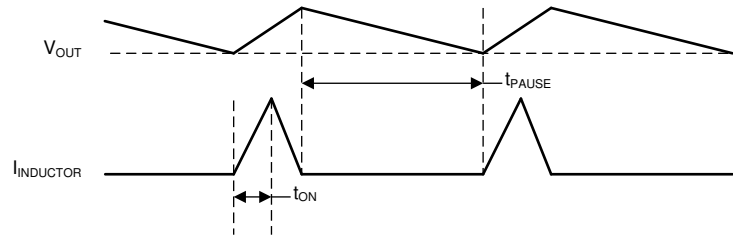
switching frequency over the whole load current range is also shown in [Switching Frequency](#) for a typical application.

$$t_{ON} = 420 \text{ ns} \times \frac{V_{OUT}}{V_{IN}}$$

$$f_{PSM} = \frac{2 \times I_{OUT}}{t_{ON}^2 \times \frac{V_{IN}}{V_{OUT}} \times \frac{V_{IN} - V_{OUT}}{L}}$$
(1)

In Power Save Mode, the output voltage rises slightly above the nominal output voltage, as shown in [Load Regulation](#). This effect is minimized by increasing the output capacitor or inductor value. The output voltage accuracy in PSM operation is reflected in the electrical specification table and given for a 22-μF output capacitor.

During PAUSE period in PSM (shown in [Figure 8-1](#)), the device does not change the PG pin state nor does it detect an UVLO event, in order to achieve a minimum quiescent current and maintain high efficiency at light loads.



**Figure 8-1. Power Save Mode Waveform Diagram**

### 8.3.2 100% Duty Cycle Low Dropout Operation

The devices offer low input-to-output voltage difference by entering 100% duty cycle mode. In this mode, the high-side MOSFET switch is constantly turned on and the low-side MOSFET is switched off. This is particularly useful in battery powered applications to achieve the longest operation time by taking full advantage of the whole battery voltage range. The minimum input voltage to maintain output regulation, depending on the load current and output voltage can be calculated as:

$$V_{IN,MIN} = V_{OUT} + I_{OUT,MAX} \times (R_{DS(on)} + R_L)$$
(2)

with

- $V_{IN,MIN}$  = Minimum input voltage to maintain an output voltage
- $I_{OUT,MAX}$  = Maximum output current
- $R_{DS(on)}$  = High-side FET ON-resistance
- $R_L$  = Inductor ohmic resistance (DCR)

### 8.3.3 Soft Start

The TPS62085, TPS62086, and TPS62087 have an internal soft-start circuitry which monotonically ramps up the output voltage and reaches the nominal output voltage during a soft-start time of typically 0.8 ms. This avoids excessive inrush current and creates a smooth output voltage slope. It also prevents excessive voltage drops of primary cells and rechargeable batteries with high internal impedance. The device is able to start into a prebiased output capacitor. The device starts with the applied bias voltage and ramps the output voltage to its nominal value.

### 8.3.4 Switch Current Limit and Hiccup Short-Circuit Protection

The switch current limit prevents the devices from high inductor current and from drawing excessive current from the battery or input voltage rail. Excessive current might occur with a shorted or saturated inductor or a heavy



load or shorted output circuit condition. If the inductor current reaches the threshold  $I_{LIM}$ , the high-side MOSFET is turned off and the low-side MOSFET is turned on to ramp down the inductor current. When this switch current limits is triggered 32 times, the devices stop switching and enable the output discharge. The devices then automatically start a new start-up after a typical delay time of 66  $\mu$ s has passed. This is named HICCUP short-circuit protection. The devices repeat this mode until the high load condition disappears.

### 8.3.5 Undervoltage Lockout

To avoid misoperation of the device at low input voltages, an undervoltage lockout (UVLO) is implemented, which shuts down the devices at voltages lower than  $V_{UVLO}$  with a hysteresis of 200 mV.

### 8.3.6 Thermal Shutdown

The device goes into thermal shutdown and stops switching when the junction temperature exceeds  $T_{JSD}$ . When the device temperature falls below the threshold by 20°C, the device returns to normal operation automatically.

## 8.4 Device Functional Modes

### 8.4.1 Enable and Disable

The devices are enabled by setting the EN pin to a logic HIGH. Accordingly, shutdown mode is forced if the EN pin is pulled LOW with a shutdown current of typically 0.7  $\mu$ A.

In shutdown mode, the internal power switches as well as the entire control circuitry are turned off. An internal resistor of 260  $\Omega$  discharges the output through the VOS pin smoothly. The output discharge function also works when thermal shutdown, UVLO, or short-circuit protection are triggered.

An internal pulldown resistor of 400 k $\Omega$  is connected to the EN pin when the EN pin is LOW. The pulldown resistor is disconnected when the EN pin is HIGH.

### 8.4.2 Power Good

The TPS62085, TPS62086, and TPS62087 have a power good output. The power good goes high impedance once the output is above 95% of the nominal voltage, and is driven low once the output voltage falls below typically 90% of the nominal voltage. The PG pin is an open-drain output and is specified to sink up to 1 mA. The power good output requires a pullup resistor connecting to any voltage rail less than 6 V. The PG signal can be used for sequencing of multiple rails by connecting it to the EN pin of other converters. Leave the PG pin unconnected when not used. 表 8-1 shows the PG pin logic.

**表 8-1. PG Pin Logic**

| DEVICE CONDITIONS    |                                     | LOGIC STATUS |     |
|----------------------|-------------------------------------|--------------|-----|
|                      |                                     | HIGH Z       | LOW |
| Enable               | EN = High, $V_{FB} \geq V_{PG}$     | √            |     |
|                      | EN = High, $V_{FB} < V_{PG}$        |              | √   |
| Shutdown             | EN = Low                            |              | √   |
| Thermal Shutdown     | $T_J > T_{JSD}$                     |              | √   |
| UVLO                 | $0.5 \text{ V} < V_{IN} < V_{UVLO}$ |              | √   |
| Power Supply Removal | $V_{IN} \leq 0.5 \text{ V}$         | √            |     |

## 9 Application and Implementation

### Note

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes, as well as validating and testing their design implementation to confirm system functionality.

### 9.1 Application Information

The TPS62085 is a synchronous step-down converter in which output voltage is adjusted by component selection. The following section discusses the design of the external components to complete the power supply design for several input and output voltage options by using typical applications as a reference. The TPS62086 and TPS62087 devices provide a fixed output voltage which does not need an external resistor divider.

### 9.2 Typical Application

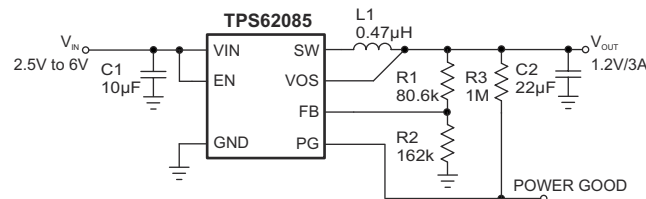


图 9-1. 1.2-V Output Voltage Application

#### 9.2.1 Design Requirements

For this design example, use the parameters listed in 表 9-1 as the input parameters.

表 9-1. Design Parameters

| DESIGN PARAMETER       | EXAMPLE VALUE |
|------------------------|---------------|
| Input voltage          | 2.5 V to 6 V  |
| Output voltage         | 1.2 V         |
| Output ripple voltage  | <20 mV        |
| Maximum output current | 3 A           |

表 9-2 lists the components used for the example.

表 9-2. List of Components

| REFERENCE | DESCRIPTION                                                                | MANUFACTURER |
|-----------|----------------------------------------------------------------------------|--------------|
| C1        | 10 µF, Ceramic capacitor, 6.3 V, X7R, size 0805, GRM21BR71A106ME51L        | Murata       |
| C2        | 22 µF, Ceramic capacitor, 6.3 V, X5R, size 0805, GRM21BR60J226ME39L        | Murata       |
| L1        | 0.47 µH, Power Inductor, size 4 mm × 4 mm × 1.5 mm, XFL4015-471ME          | Coilcraft    |
| R1        | Depending on the output voltage, 1%, size 0603; 0 Ω for TPS62086, TPS62087 | Std          |
| R2        | 162 kΩ, Chip resistor, 1/16 W, 1%, size 0603; open for TPS62086, TPS62087  | Std          |
| R3        | 1 MΩ, Chip resistor, 1/16 W, 1%, size 0603                                 | Std          |

#### 9.2.2 Detailed Design Procedure

##### 9.2.2.1 Custom Design With WEBENCH® Tools

[Click here](#) to create a custom design using the TPS62085 device with the WEBENCH® Power Designer.

[Click here](#) to create a custom design using the TPS62086 device with the WEBENCH® Power Designer.

[Click here](#) to create a custom design using the TPS62087 device with the WEBENCH® Power Designer.

1. Start by entering the input voltage ( $V_{IN}$ ), output voltage ( $V_{OUT}$ ), and output current ( $I_{OUT}$ ) requirements.
2. Optimize the design for key parameters such as efficiency, footprint, and cost using the optimizer dial.
3. Compare the generated design with other possible solutions from Texas Instruments.

The WEBENCH Power Designer provides a customized schematic along with a list of materials with real-time pricing and component availability.

In most cases, these actions are available:

- Run electrical simulations to see important waveforms and circuit performance
- Run thermal simulations to understand board thermal performance
- Export customized schematic and layout into popular CAD formats
- Print PDF reports for the design, and share the design with colleagues

Get more information about WEBENCH tools at [www.ti.com/WEBENCH](http://www.ti.com/WEBENCH).

### 9.2.2.2 Setting The Output Voltage

The output voltage is set by an external resistor divider according to 式 3:

$$V_{OUT} = V_{FB} \times \left(1 + \frac{R1}{R2}\right) = 0.8 \text{ V} \times \left(1 + \frac{R1}{R2}\right) \quad (3)$$

$R2$  must not be higher than 180 k $\Omega$  to achieve high efficiency at light load while providing acceptable noise sensitivity. Lowest operating quiescent current and best output voltage accuracy are achieved with the fixed output voltage versions. For the fixed output voltage versions, the FB pin must be connected to the output.

### 9.2.2.3 Output Filter Design

The inductor and the output capacitor together provide a low-pass filter. To simplify the selection process, 表 9-3 outlines possible inductor and capacitor value combinations for most applications.

**表 9-3. Matrix of Output Capacitor and Inductor Combinations**

| NOMINAL L [ $\mu$ H] <sup>(2)</sup> | NOMINAL C <sub>OUT</sub> [ $\mu$ F] <sup>(3)</sup> |      |    |     |     |
|-------------------------------------|----------------------------------------------------|------|----|-----|-----|
|                                     | 10                                                 | 22   | 47 | 100 | 150 |
| 0.47                                |                                                    | +(1) | +  | +   | +   |
| 1                                   | +                                                  | +    | +  | +   | +   |
| 2.2                                 |                                                    |      |    |     |     |

- (1) Typical application configuration. Other '+' mark indicates recommended filter combinations.  
 (2) Inductor tolerance and current derating is anticipated. The effective inductance can vary by 20% and -30%.  
 (3) Capacitance tolerance and bias voltage derating is anticipated. The effective capacitance can vary by 20% and -50%.

### 9.2.2.4 Inductor Selection

The main parameter for the inductor selection is the inductor value and then the saturation current of the inductor. To calculate the maximum inductor current under static load conditions, 式 4 is given.

$$I_{L,MAX} = I_{OUT,MAX} + \frac{\Delta I_L}{2}$$

$$\Delta I_L = V_{OUT} \times \frac{1 - \frac{V_{OUT}}{V_{IN}}}{L \times f_{SW}} \quad (4)$$

where

- $I_{OUT,MAX}$  = Maximum output current
- $\Delta I_L$  = Inductor current ripple
- $f_{SW}$  = Switching frequency
- $L$  = Inductor value

TI recommends choosing the saturation current for the inductor 20% to 30% higher than the  $I_{L,MAX}$ , out of 式 4. A higher inductor value is also useful to lower ripple current but increases the transient response time as well. The following inductors are recommended to be used in designs.

**表 9-4. List of Recommended Inductors**

| INDUCTANCE<br>[μH] | CURRENT RATING<br>[A] | DIMENSIONS<br>L × W × H [mm <sup>3</sup> ] | DC RESISTANCE<br>[mΩ typical] | PART NUMBER            |
|--------------------|-----------------------|--------------------------------------------|-------------------------------|------------------------|
| 0.47               | 6.6                   | 4 × 4 × 1.5                                | 7.6                           | Coilcraft XFL4015-471  |
| 0.47               | 6.7                   | 3.2 × 2.5 × 1.2                            | 23                            | Murata DFE322512F-R47N |
| 1                  | 5.1                   | 4 × 4 × 2                                  | 10.8                          | Coilcraft XFL4020-102  |

### 9.2.2.5 Capacitor Selection

The input capacitor is the low-impedance energy source for the converters which helps to provide stable operation. A low ESR multilayer ceramic capacitor is recommended for best filtering and must be placed between VIN and GND as close as possible to those pins. For most applications, 10 μF is sufficient, though a larger value reduces input current ripple.

The architecture of the TPS62085, TPS62086, and TPS62087 allows the use of tiny ceramic output capacitors with low equivalent series resistance (ESR). These capacitors provide low output voltage ripple and are recommended. To keep its low resistance up to high frequencies and to get narrow capacitance variation with temperature, TI recommends using X7R or X5R dielectrics. The recommended typical output capacitor value is 22 μF; this capacitance can vary over a wide range as outline in the output filter selection table. Output capacitors above 150 μF may be used with a reduced load current during startup to avoid triggering the short circuit protection.

A feed-forward capacitor is not required for device proper operation.

### 9.2.3 Application Curves

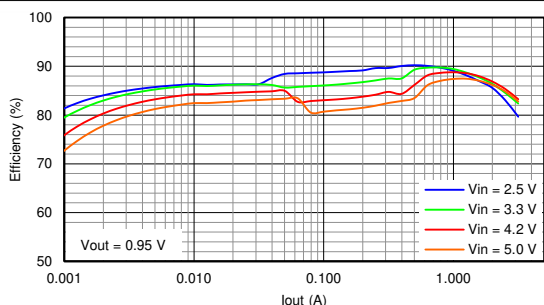
$V_{IN} = 3.6\text{ V}$ ,  $V_{OUT} = 1.2\text{ V}$ ,  $T_A = 25^\circ\text{C}$ , unless otherwise noted

**表 9-5. Table of Graphs**

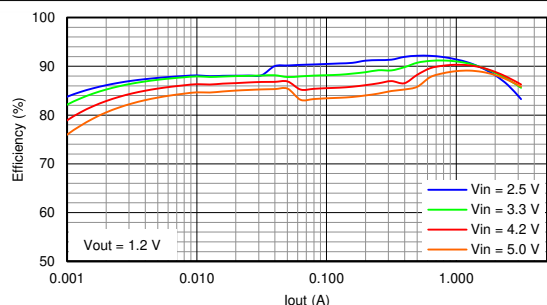
|                     |                                     | FIGURE                              |
|---------------------|-------------------------------------|-------------------------------------|
| Efficiency          | TPS62085, $V_{OUT} = 0.95\text{ V}$ | <a href="#">Efficiency</a>          |
|                     | TPS62085, $V_{OUT} = 1.2\text{ V}$  | <a href="#">Efficiency</a>          |
|                     | TPS62086, $V_{OUT} = 3.3\text{ V}$  | <a href="#">Efficiency</a>          |
|                     | TPS62087, $V_{OUT} = 1.8\text{ V}$  | <a href="#">Efficiency</a>          |
| Line Regulation     | TPS62085                            | <a href="#">Line Regulation</a>     |
| Load Regulation     | TPS62085                            | <a href="#">Load Regulation</a>     |
| Switching Frequency | TPS62085                            | <a href="#">Switching Frequency</a> |

**表 9-5. Table of Graphs (continued)**

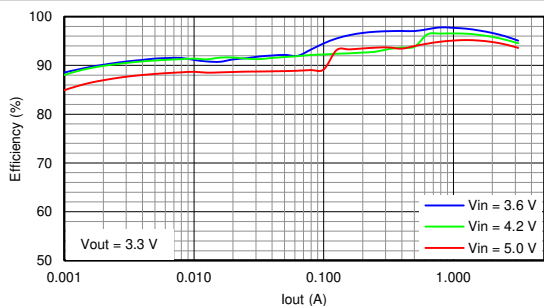
|           |                                                                                   | FIGURE                                                                 |
|-----------|-----------------------------------------------------------------------------------|------------------------------------------------------------------------|
| Waveforms | TPS62085, PWM Operation (Load = 3 A)                                              | PWM Operation, Load = 3 A                                              |
|           | TPS62085, PSM Operation (Load = 100 mA)                                           | PSM Operation, Load = 100 mA                                           |
|           | TPS62085, Load Sweep (Load = Open to 3 A)                                         | Load Sweep, Load = Open to 3 A                                         |
|           | TPS62085, Start-Up (Load = 0.47 $\Omega$ )                                        | Start-Up, Load = 0.47 $\Omega$                                         |
|           | TPS62085, Start-Up (Load = Open)                                                  | Start-Up, Load = Open                                                  |
|           | TPS62085, Shutdown (Load = 0.47 $\Omega$ )                                        | Shutdown, Load = 0.47 $\Omega$                                         |
|           | TPS62085, Shutdown (Load = Open)                                                  | Shutdown, Load = Open                                                  |
|           | TPS62085, Load Transient (Load = 0.5 A to 3 A)                                    | Load Transient, Load = 0.5 A to 3 A                                    |
|           | TPS62085, Load Transient (Load = 50 mA to 3 A)                                    | Load Transient, Load = 50 mA to 3 A                                    |
|           | TPS62085, Output Short-Circuit Protection (Load = 0.47 $\Omega$ , Entry)          | Output Short-Circuit Protection, Load = 0.47 $\Omega$ , Entry          |
|           | TPS62085, Output Short-Circuit Protection (Load = 0.47 $\Omega$ , Recovery)       | Output Short-Circuit Protection, Load = 0.47 $\Omega$ , Recovery       |
|           | TPS62085, Output Short-Circuit Protection (Load = 0.47 $\Omega$ , HICCUP Zoom In) | Output Short-Circuit Protection, Load = 0.47 $\Omega$ , HICCUP Zoom In |



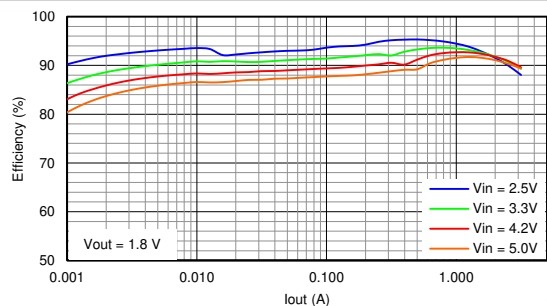
**图 9-2. Efficiency**



**图 9-3. Efficiency**



**图 9-4. Efficiency**



**图 9-5. Efficiency**

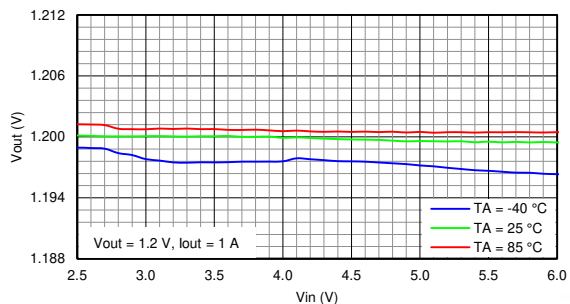


图 9-6. Line Regulation

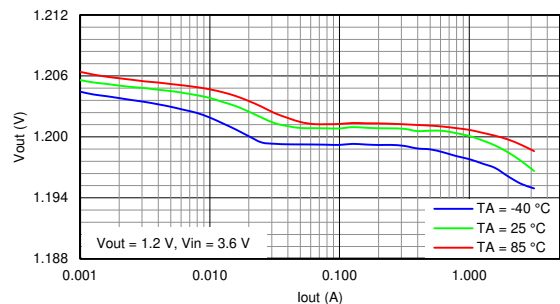


图 9-7. Load Regulation

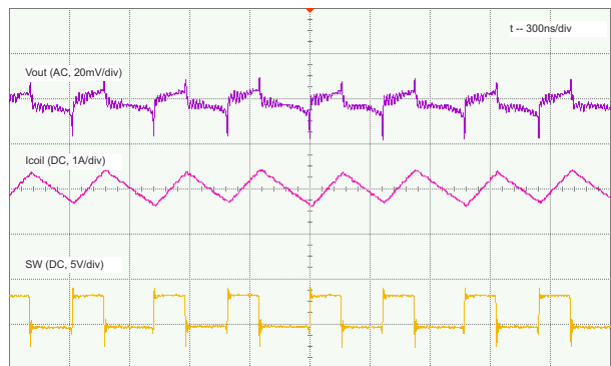


图 9-8. PWM Operation, Load = 3 A

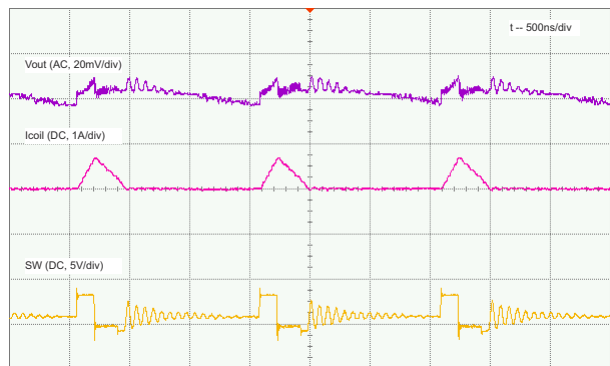


图 9-9. PSM Operation, Load = 100 mA

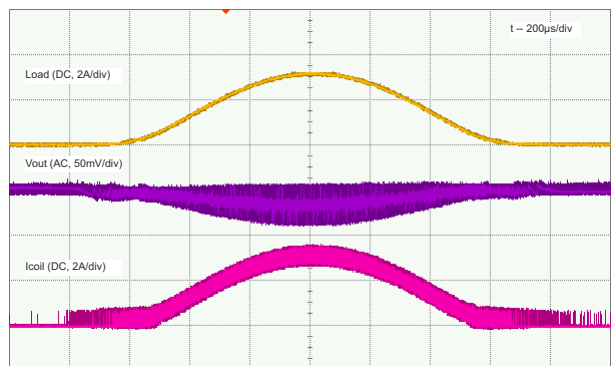


图 9-10. Load Sweep, Load = Open to 3 A

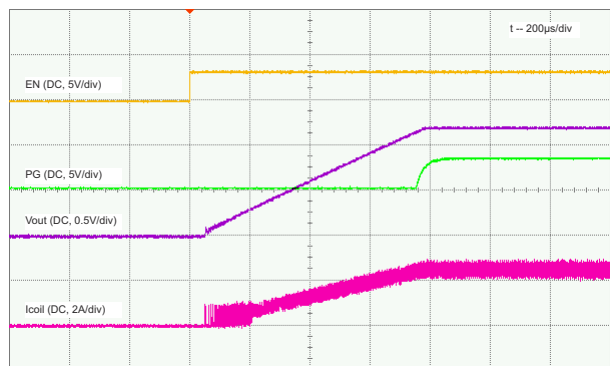


图 9-11. Start-Up, Load = 0.47  $\Omega$

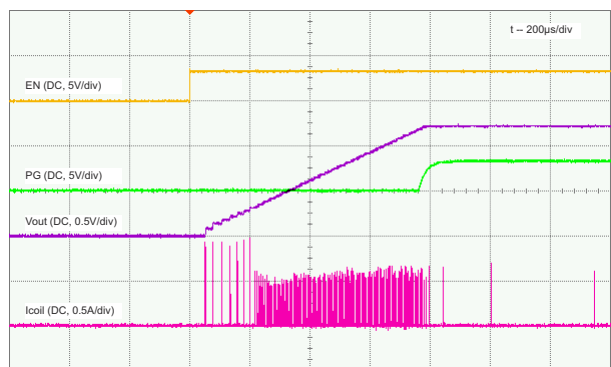


图 9-12. Start-Up, Load = Open

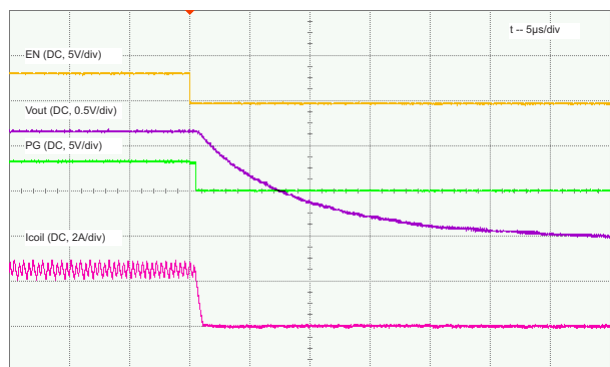
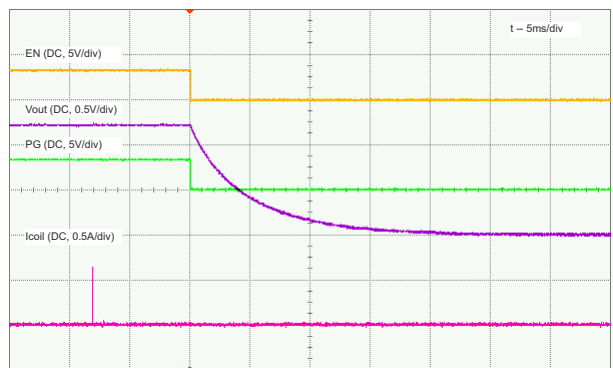
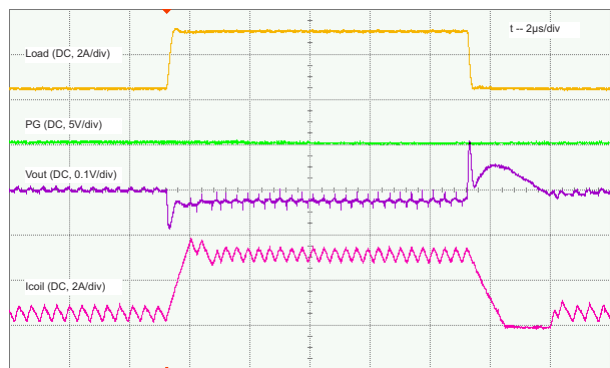


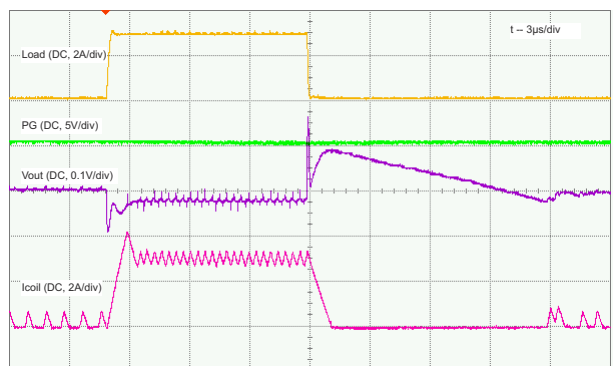
图 9-13. Shutdown, Load = 0.47  $\Omega$



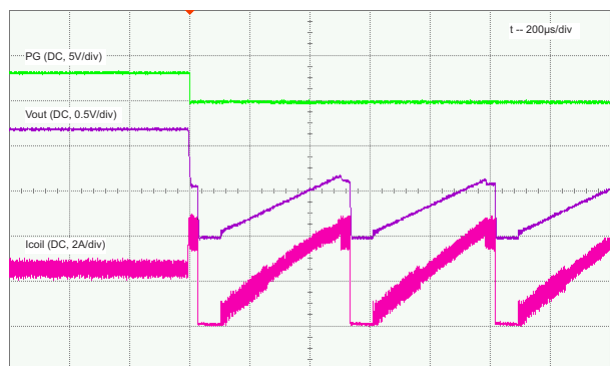
**图 9-14. Shutdown, Load = Open**



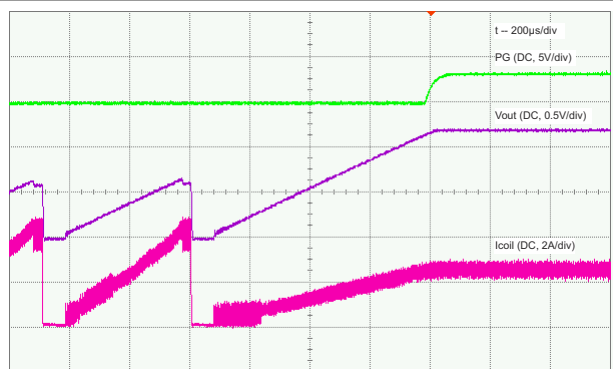
**图 9-15. Load Transient, Load = 0.5 A to 3 A**



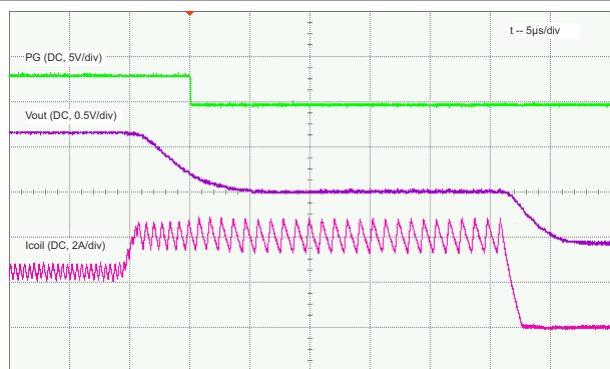
**图 9-16. Load Transient, Load = 50 mA to 3 A**



**图 9-17. Output Short-Circuit Protection, Load = 0.47 Ω, Entry**



**图 9-18. Output Short-Circuit Protection, Load = 0.47 Ω, Recovery**



**图 9-19. Output Short-Circuit Protection, Load = 0.47 Ω, HICCUP Zoom In**

## 10 Power Supply Recommendations

The device is designed to operate from an input voltage supply range from 2.5 V to 6 V. Ensure that the input power supply has a sufficient current rating for the application.

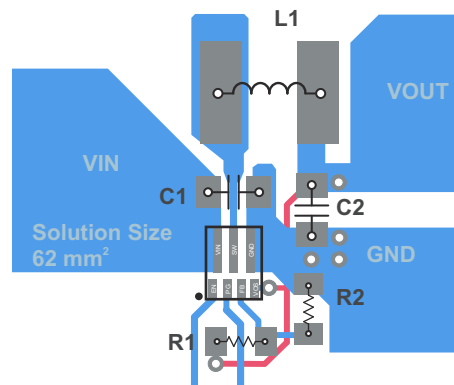
## 11 Layout

### 11.1 Layout Guidelines

The printed-circuit-board (PCB) layout is an important step to maintain the high performance of the TPS62085, TPS62086, and TPS62087 devices.

The input and output capacitors and the inductor must be placed as close as possible to the IC. This keeps the traces short. Routing these traces direct and wide results in low trace resistance and low parasitic inductance. The low side of the input and output capacitors must be connected directly to the GND pin to avoid a ground potential shift. The sense traces connected to FB and VOS pins are signal traces. Special care must be taken to avoid noise being induced. By a direct routing, parasitic inductance can be kept small. GND layers might be used for shielding. Keep these traces away from SW nodes. See [Figure 11-1](#) for the recommended PCB layout.

### 11.2 Layout Example



**Figure 11-1. PCB Layout Recommendation**

### 11.3 Thermal Considerations

Implementation of integrated circuits in low-profile and fine-pitch surface-mount packages typically requires special attention to power dissipation. Many system-dependent issues such as thermal coupling, airflow, added heat sinks and convection surfaces, and the presence of other heat-generating components affect the power dissipation limits of a given component.

Two basic approaches for enhancing thermal performance are:

- Improving the power dissipation capability of the PCB design
- Introducing airflow in the system

The Thermal Data section in the *TPS62085EVM-169 Evaluation Module User's Guide* ([SLVU809](#)) provides the thermal metric of the device on the EVM after considering the PCB design of real applications. The big copper planes connecting to the pads of the IC on the PCB improve the thermal performance of the device. For more details on how to use the thermal parameters, see the *Thermal Characteristics Application Notes*, [SZZA017](#) and [SPRA953](#).



## 12 Device and Documentation Support

### 12.1 Device Support

#### 12.1.1 Development Support

##### 12.1.1.1 Custom Design With WEBENCH® Tools

[Click here](#) to create a custom design using the TPS62085 device with the WEBENCH® Power Designer.

[Click here](#) to create a custom design using the TPS62086 device with the WEBENCH® Power Designer.

[Click here](#) to create a custom design using the TPS62087 device with the WEBENCH® Power Designer.

1. Start by entering the input voltage ( $V_{IN}$ ), output voltage ( $V_{OUT}$ ), and output current ( $I_{OUT}$ ) requirements.
2. Optimize the design for key parameters such as efficiency, footprint, and cost using the optimizer dial.
3. Compare the generated design with other possible solutions from Texas Instruments.

The WEBENCH Power Designer provides a customized schematic along with a list of materials with real-time pricing and component availability.

In most cases, these actions are available:

- Run electrical simulations to see important waveforms and circuit performance
- Run thermal simulations to understand board thermal performance
- Export customized schematic and layout into popular CAD formats
- Print PDF reports for the design, and share the design with colleagues

Get more information about WEBENCH tools at [www.ti.com/WEBENCH](http://www.ti.com/WEBENCH).

### 12.2 Documentation Support

#### 12.2.1 Related Documentation

For related documentation, see the following:

- *TPS62085EVM-169 Evaluation Module User's Guide*, [SLVU809](#)
- *Thermal Characteristics Application Note*, [SZZA017](#)
- *Thermal Characteristics Application Note*, [SPRA953](#)

### 12.3 ドキュメントの更新通知を受け取る方法

ドキュメントの更新についての通知を受け取るには、[ti.com](http://ti.com) のデバイス製品フォルダを開いてください。「更新の通知を受け取る」をクリックして登録すると、変更されたすべての製品情報に関するダイジェストを毎週受け取れます。変更の詳細については、修正されたドキュメントに含まれている改訂履歴をご覧ください。

### 12.4 サポート・リソース

[TI E2E™ サポート・フォーラム](#)は、エンジニアが検証済みの回答と設計に関するヒントをエキスパートから迅速かつ直接得ることができる場所です。既存の回答を検索したり、独自の質問をしたりすることで、設計に必要な支援を迅速に得ることができます。

リンクされているコンテンツは、該当する貢献者により、現状のまま提供されるものです。これらは TI の仕様を構成するものではなく、必ずしも TI の見解を反映したものではありません。TI の[使用条件](#)を参照してください。

### 12.5 Trademarks

DCS-Control™ is a trademark of TI.

TI E2E™ is a trademark of Texas Instruments.

WEBENCH® are registered trademarks of Texas Instruments.

すべての商標は、それぞれの所有者に帰属します。

## 12.6 静電気放電に関する注意事項



この IC は、ESD によって破損する可能性があります。テキサス・インスツルメンツは、IC を取り扱う際には常に適切な注意を払うことを推奨します。正しい ESD 対策をとらないと、デバイスを破損するおそれがあります。

ESD による破損は、わずかな性能低下からデバイスの完全な故障まで多岐にわたります。精密な IC の場合、パラメータがわずかに変化するだけで公表されている仕様から外れる可能性があるため、破損が発生しやすくなっています。

## 12.7 用語集

**TI 用語集** この用語集には、用語や略語の一覧および定義が記載されています。

## Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

## PACKAGING INFORMATION

| Orderable part number        | Status<br>(1) | Material type<br>(2) | Package   Pins    | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|------------------------------|---------------|----------------------|-------------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">TPS62085RLTR</a> | Active        | Production           | VSON-HR (RLT)   7 | 3000   LARGE T&R      | Yes         | Call TI   Sn                         | Level-1-260C-UNLIM                | -40 to 125   | PD5Q                |
| TPS62085RLTR.A               | Active        | Production           | VSON-HR (RLT)   7 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | PD5Q                |
| TPS62085RLTR.B               | Active        | Production           | VSON-HR (RLT)   7 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | PD5Q                |
| <a href="#">TPS62085RLTT</a> | Active        | Production           | VSON-HR (RLT)   7 | 250   SMALL T&R       | Yes         | Call TI   Sn                         | Level-1-260C-UNLIM                | -40 to 125   | PD5Q                |
| TPS62085RLTT.A               | Active        | Production           | VSON-HR (RLT)   7 | 250   SMALL T&R       | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | PD5Q                |
| TPS62085RLTT.B               | Active        | Production           | VSON-HR (RLT)   7 | 250   SMALL T&R       | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | PD5Q                |
| <a href="#">TPS62086RLTR</a> | Active        | Production           | VSON-HR (RLT)   7 | 3000   LARGE T&R      | Yes         | Call TI   Sn                         | Level-1-260C-UNLIM                | -40 to 125   | PD4Q                |
| TPS62086RLTR.B               | Active        | Production           | VSON-HR (RLT)   7 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | PD4Q                |
| <a href="#">TPS62086RLTT</a> | Active        | Production           | VSON-HR (RLT)   7 | 250   SMALL T&R       | Yes         | Call TI   Sn                         | Level-1-260C-UNLIM                | -40 to 125   | PD4Q                |
| TPS62086RLTT.B               | Active        | Production           | VSON-HR (RLT)   7 | 250   SMALL T&R       | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | PD4Q                |
| <a href="#">TPS62087RLTR</a> | Active        | Production           | VSON-HR (RLT)   7 | 3000   LARGE T&R      | Yes         | Call TI   Sn                         | Level-1-260C-UNLIM                | -40 to 125   | PD3Q                |
| TPS62087RLTR.B               | Active        | Production           | VSON-HR (RLT)   7 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | PD3Q                |
| <a href="#">TPS62087RLTT</a> | Active        | Production           | VSON-HR (RLT)   7 | 250   SMALL T&R       | Yes         | Call TI   Sn                         | Level-1-260C-UNLIM                | -40 to 125   | PD3Q                |
| TPS62087RLTT.B               | Active        | Production           | VSON-HR (RLT)   7 | 250   SMALL T&R       | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | PD3Q                |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

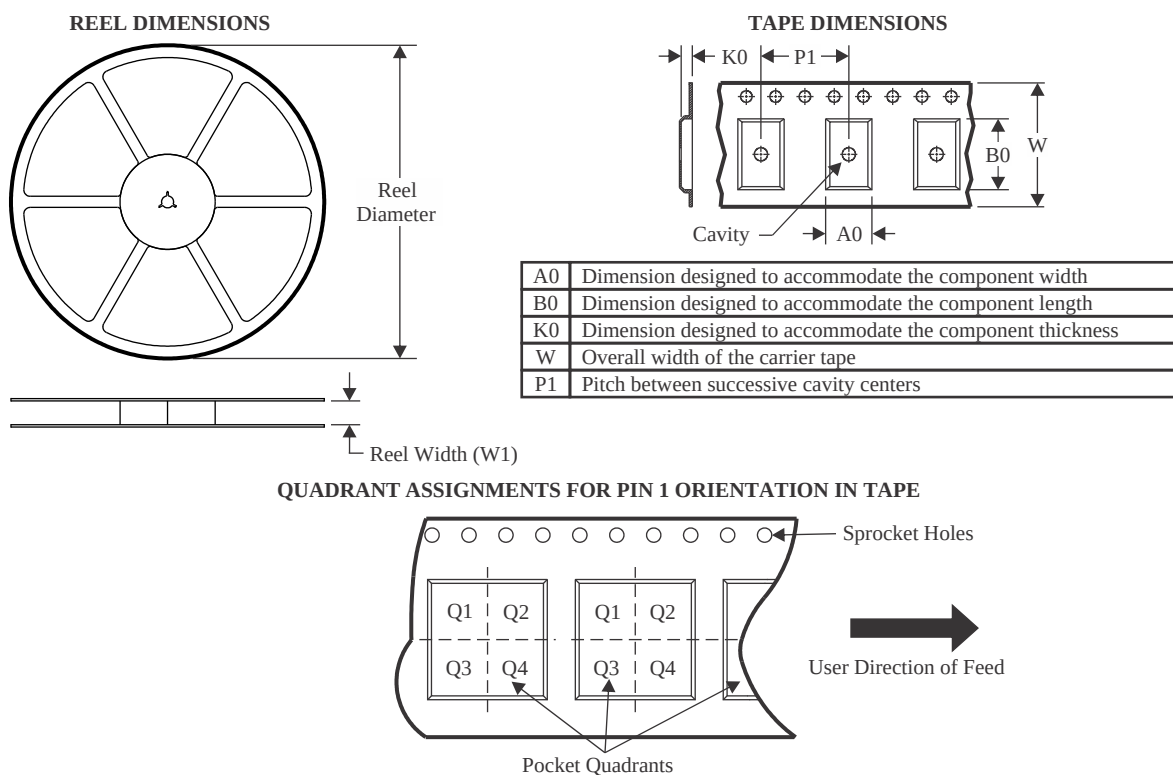
<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

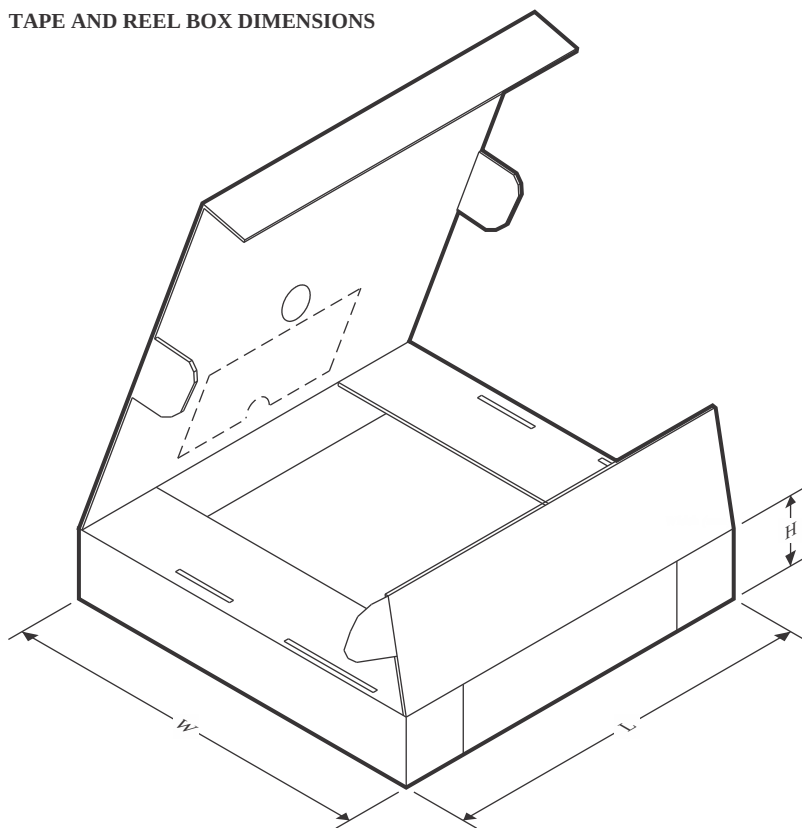
## TAPE AND REEL INFORMATION



\*All dimensions are nominal

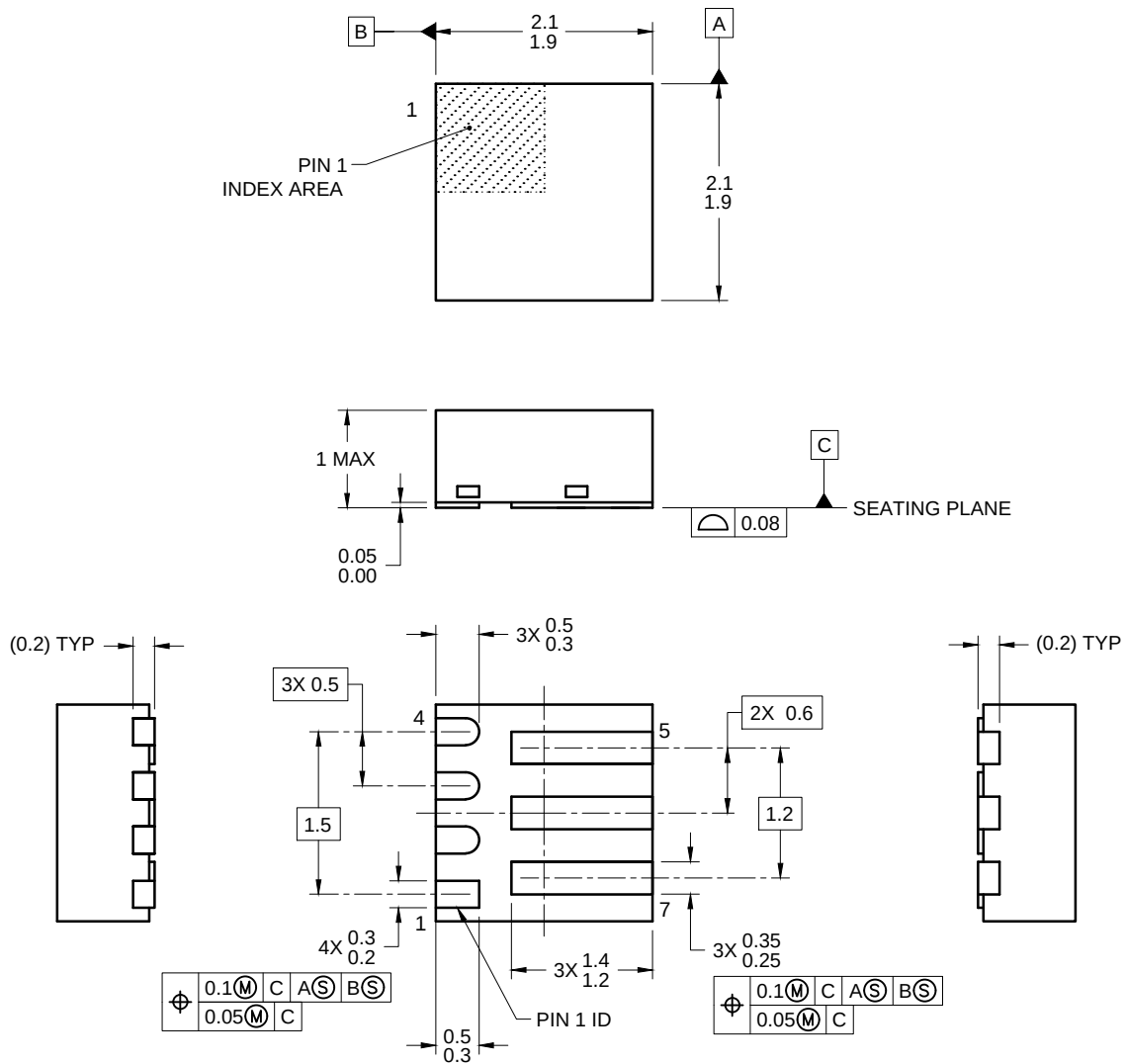
| Device       | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| TPS62085RLTR | VSON-HR      | RLT             | 7    | 3000 | 180.0              | 8.4                | 2.3     | 2.3     | 1.15    | 4.0     | 8.0    | Q2            |
| TPS62085RLTT | VSON-HR      | RLT             | 7    | 250  | 180.0              | 8.4                | 2.3     | 2.3     | 1.15    | 4.0     | 8.0    | Q2            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

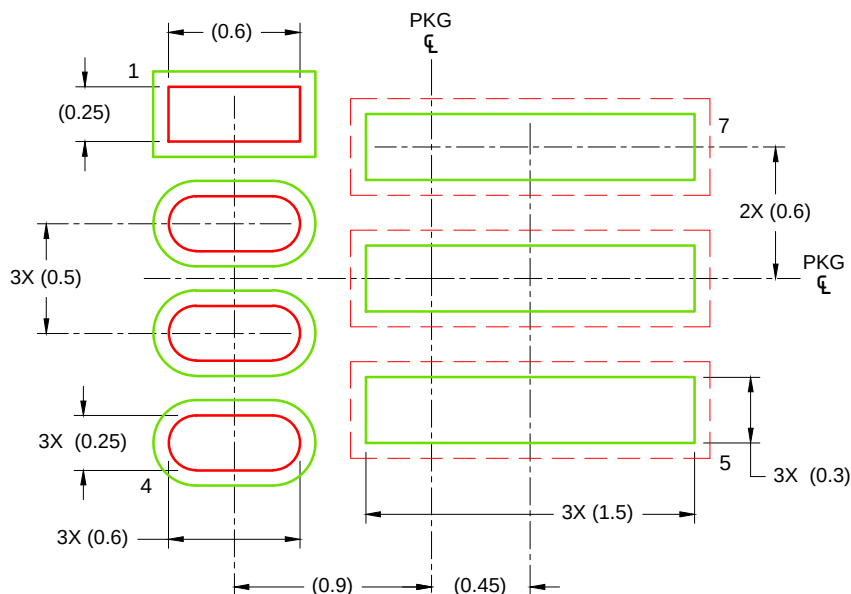
| Device       | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|--------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TPS62085RLTR | VSON-HR      | RLT             | 7    | 3000 | 210.0       | 185.0      | 35.0        |
| TPS62085RLTT | VSON-HR      | RLT             | 7    | 250  | 210.0       | 185.0      | 35.0        |



4220429/A 09/2014

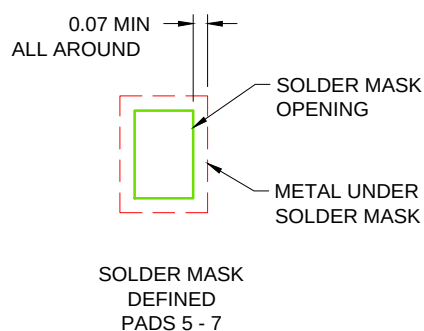
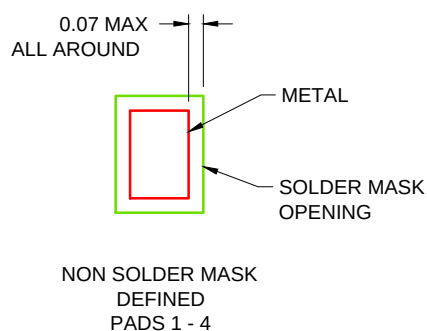
## NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.



LAND PATTERN EXAMPLE

SCALE: 30X



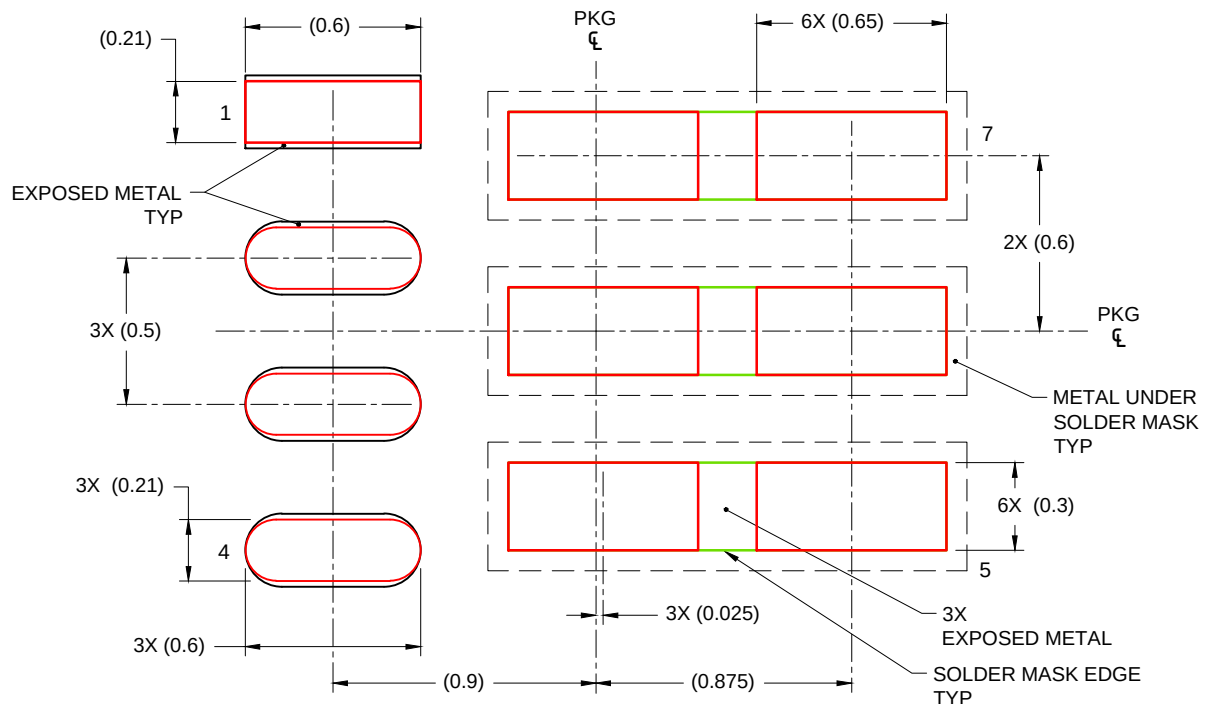
SOLDER MASK DETAILS

4220429/A 09/2014

NOTES: (continued)

3. For more information, see Texas Instruments literature number SLUA271 ([www.ti.com/lit/sluea271](http://www.ti.com/lit/sluea271)).
4. Solder mask tolerances between and around signal pads can vary based on board fabrication site.
5. Vias should not be placed on soldering pads unless they are plugged or plated shut.





**SOLDER PASTE EXAMPLE**  
 BASED ON 0.125 mm THICK STENCIL

FOR ALL EXPOSED PADS  
 85% PRINTED SOLDER COVERAGE BY AREA  
 SCALE: 40X

4220429/A 09/2014

NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

## 重要なお知らせと免責事項

TI は、技術データと信頼性データ (データシートを含みます)、設計リソース (リファレンス デザインを含みます)、アプリケーションや設計に関する各種アドバイス、Web ツール、安全性情報、その他のリソースを、欠陥が存在する可能性のある「現状のまま」提供しており、商品性および特定目的に対する適合性の黙示保証、第三者の知的財産権の非侵害保証を含みいかなる保証も、明示的または黙示的にかかわらず拒否します。

これらのリソースは、TI 製品を使用する設計の経験を積んだ開発者への提供を意図したものです。(1) お客様のアプリケーションに適した TI 製品の選定、(2) お客様のアプリケーションの設計、検証、試験、(3) お客様のアプリケーションに該当する各種規格や、その他のあらゆる安全性、セキュリティ、規制、または他の要件への確実な適合に関する責任を、お客様のみが単独で負うものとし、TI は一切の責任を拒否します。

上記の各種リソースは、予告なく変更される可能性があります。これらのリソースは、リソースで説明されている TI 製品を使用するアプリケーションの開発の目的でのみ、TI はその使用をお客様に許諾します。これらのリソースに関して、他の目的で複製することや掲載することは禁止されています。TI や第三者の知的財産権のライセンスが付与されている訳ではありません。お客様は、これらのリソースを自身で使用した結果発生するあらゆる申し立て、損害、費用、損失、責任について、TI およびその代理人を完全に補償するものとし、TI は一切の責任を拒否します。

TI の製品は、[TI の販売条件](#)、[TI の総合的な品質ガイドライン](#)、[ti.com](https://www.ti.com) または TI 製品などに関連して提供される他の適用条件に従い提供されます。TI がこれらのリソースを提供することは、適用される TI の保証または他の保証の放棄の拡大や変更を意味するものではありません。TI がカスタム、またはカスタマー仕様として明示的に指定していない限り、TI の製品は標準的なカタログに掲載される汎用機器です。

お客様がいかなる追加条項または代替条項を提案する場合も、TI はそれらに異議を唱え、拒否します。

Copyright © 2026, Texas Instruments Incorporated

最終更新日：2025 年 10 月